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## APPLICANTS

Scott G. Meikle, Boise, ID;

\*\* CONTINUING DATA \*\*\*\*\* *YES LU*

This application is a DIV of 09/649,427 08/28/2000 PAT 6,838,382

\*\* FOREIGN APPLICATIONS \*\*\*\*\* *None LU*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

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|   |  |                           |                        |                       |                            |
|---|--|---------------------------|------------------------|-----------------------|----------------------------|
| Foreign Priority claimed<br>35 USC 119 (a-d) conditions met | <input type="checkbox"/> yes <input checked="" type="checkbox"/> no<br><input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after<br>Allowance | STATE OR<br>COUNTRY<br>ID | SHEETS<br>DRAWING<br>7 | TOTAL<br>CLAIMS<br>31 | INDEPENDENT<br>CLAIMS<br>5 |
| Verified and<br>Acknowledged                                | Examiner's Signature <i>[Signature]</i><br>Initials <i>LU</i>  |                           |                        |                       |                            |

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## TITLE

Method and apparatus for forming a planarizing pad having a film and texture elements for planarization of microelectronic substrates

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|------------------------------------|---|--|
| FILING FEE<br><br>RECEIVED<br>1116 | FEES: Authority has been given in Paper<br>No. _____ to charge/credit DEPOSIT ACCOUNT<br>No. _____ for following: | <input type="checkbox"/> All Fees<br><input type="checkbox"/> 1.16 Fees ( Filing )<br><input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )<br><input type="checkbox"/> 1.18 Fees ( Issue ) |
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